FDI030N06 N-Channel PowerTrench<sup>®</sup> MOSFET 60V, 193A, 3.2mΩ

# Features

- $R_{DS(on)} = 2.6m\Omega$  (Typ.)@  $V_{GS} = 10V$ ,  $I_D = 75A$
- Fast Switching Speed

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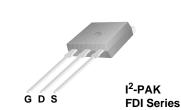
- Low Gate Charge
- High Performance Trench Technology for Extremely Low  $\mathsf{R}_{\mathsf{DS}(\mathsf{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

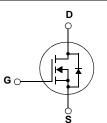
# Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

### Application

• DC to DC Convertors / Synchronous Rectification





# MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol			Ratings	Units	
V <sub>DSS</sub>	Drain to Source Voltage		60	V	
V <sub>GSS</sub>	Gate to Source Voltage			±20	V
I <sub>D</sub>		-Continuous ( $T_C = 25^{\circ}C$ , S	Silicon Limited)	193*	
	Drain Current	-Continuous ( $T_C = 100^{\circ}C$ ,	Silicon Limited)	136*	Α
		-Continuous ( $T_C = 25^{\circ}C$ , F	Package Limited)	120	
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	772	Α
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		(Note 2)	1434	mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	6	V/ns
P <sub>D</sub>	Dewer Dissignation	$(T_{\rm C} = 25^{\rm o}{\rm C})$		231	W
	Power Dissipation	- Derate above 25°C		1.54	W/ºC
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +175	°C
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C

# **Thermal Characteristics**

Symbol	Parameter	Ratings	Units			
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case	0.65	°C/W			
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient	62.5	°C/W			

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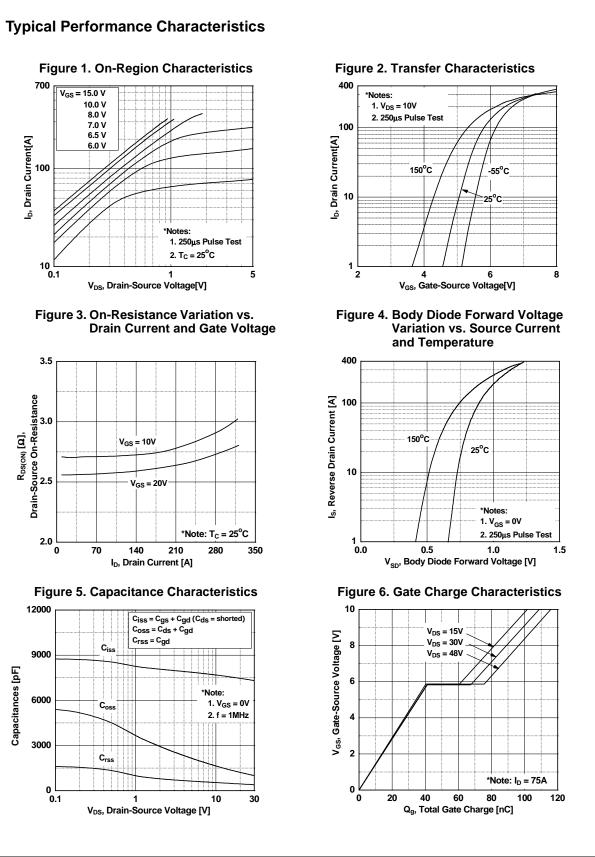


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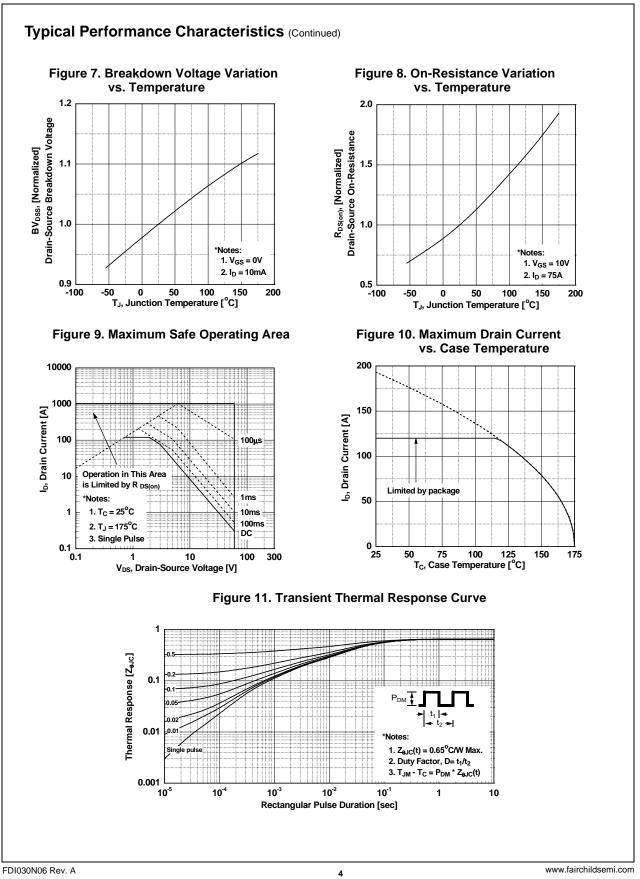
Device Marking Device		Device	Package Reel Size Tap   TO-262 - -		e Width		Quantity			
FDI030N06		FDI030N06					-		50	
Electrical	Chara	acteristics T <sub>c</sub> =	25°C unless	otherwis	e noted					
Symbol		Parameter			Test Conditions		Min.	Тур.	Max.	Units
Off Charact	eristic	5								
BV <sub>DSS</sub>	Drain to	Source Breakdown V	oltage	I <sub>D</sub> = 250	0μΑ, V <sub>GS</sub> = 0V, T <sub>C</sub>	= 25°C	60	-	-	V
ΔBV <sub>DSS</sub>		down Voltage Temperature						0.05		V/ºC
$\Delta T_{J}$	Coefficient			$I_D = 1$ mA, Referenced to 25°C			-	0.05	-	V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current		$V_{DS} = 48V, V_{GS} = 0V$			-	-	1	μA	
033			$V_{DS} = 48V, T_{C} = 150^{\circ}C$			-	-	500		
I <sub>GSS</sub>	Gate to Body Leakage Current			$V_{GS} = \pm 20V, V_{DS} = 0V$			-	-	±100	nA
On Charact	eristics	6								
V <sub>GS(th)</sub>	Gate Th	reshold Voltage		$V_{GS} = V_{SS}$	/ <sub>DS</sub> , I <sub>D</sub> = 250μA		2.5	3.5	4.5	V
R <sub>DS(on)</sub>	Static D	rain to Source On Res	sistance		10V, I <sub>D</sub> = 75A		-	2.6	3.2	mΩ
9FS	Forward	Transconductance			0V, I <sub>D</sub> = 75A	(Note 4)	-	154	-	S
		riotion				1				1
Dynamic Cl				1				7000	0045	- 5
C <sub>iss</sub>				V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V f = 1MHz		-	-	7380	9815	pF pF
C <sub>oss</sub>		Capacitance Transfer Capacitance	<b>`</b>			-	1095 415	1455 625	pF pF	
C <sub>rss</sub>		te Charge at 10V	5				-	116	151	nC
Q <sub>g(tot)</sub> Q <sub>gs</sub>		Source Gate Charge		V <sub>DS</sub> = 48V, I <sub>D</sub> = 75A		-	-	40	-	nC
		o Drain "Miller" Charge		$V_{GS} = 10V$			-	35	-	nC
Q <sub>gd</sub>	Gale IU	Dialiti Miller Charge				(Note 4, 5)	-	55	-	ne
Switching (	Charact	teristics								
t <sub>d(on)</sub>	Turn-On	Delay Time					-	39	87	ns
t <sub>r</sub>	Turn-On	Rise Time		V <sub>DD</sub> = 30V, I <sub>D</sub> = 75A			-	178	366	ns
t <sub>d(off)</sub>	Turn-Off	Delay Time		V <sub>GS</sub> = '	10V, $R_{GEN} = 4.7\Omega$		-	54	118	ns
t <sub>f</sub>	Turn-Off	Fall Time		(Note 4, 5)			-	33	76	ns
Drain-Sour	ce Diod	le Characteristic	S							
I <sub>S</sub>	Maximur	n Continuous Drain to	Source Diode	e Forwar	d Current		-	-	193	А
I <sub>SM</sub>	Maximur	aximum Pulsed Drain to Source Diode Fo		rward Current		-	-	772	А	
V <sub>SD</sub>	Drain to	Source Diode Forward	d Voltage	$V_{GS} = 0$	IV, I <sub>SD</sub> = 75A		-	-	1.3	V
t <sub>rr</sub>	Reverse	Recovery Time		$V_{GS} = 0$	)V, I <sub>SD</sub> = 75A		-	46	-	ns
Q <sub>rr</sub>	Reverse	Recovery Charge			100A/µs	(Note 4)	-	50	-	nC
2. L = 0.51mH, I <sub>AS</sub> = 3. I <sub>SD</sub> ≤ 75A, di/dt ≤ 4. Pulse Test: Pulse	= 75A, V <sub>DD</sub> = 450A/µs, V <sub>D</sub> width ≤ 300	I limited by maximum junction $500$ , $R_G = 25\Omega$ , Starting T <sub>J</sub> = $p_D \le BV_{DSS}$ , Starting T <sub>J</sub> = $25^{\circ}$ $\mu$ s, Duty Cycle $\le 2\%$ berating Temperature Typical	= 25°C C							

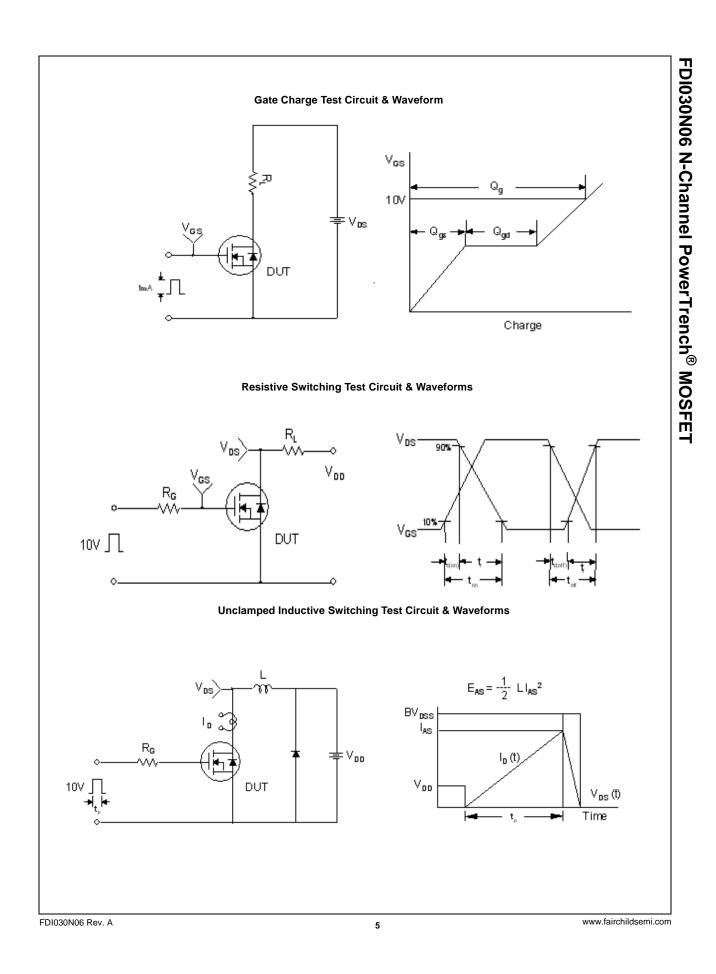
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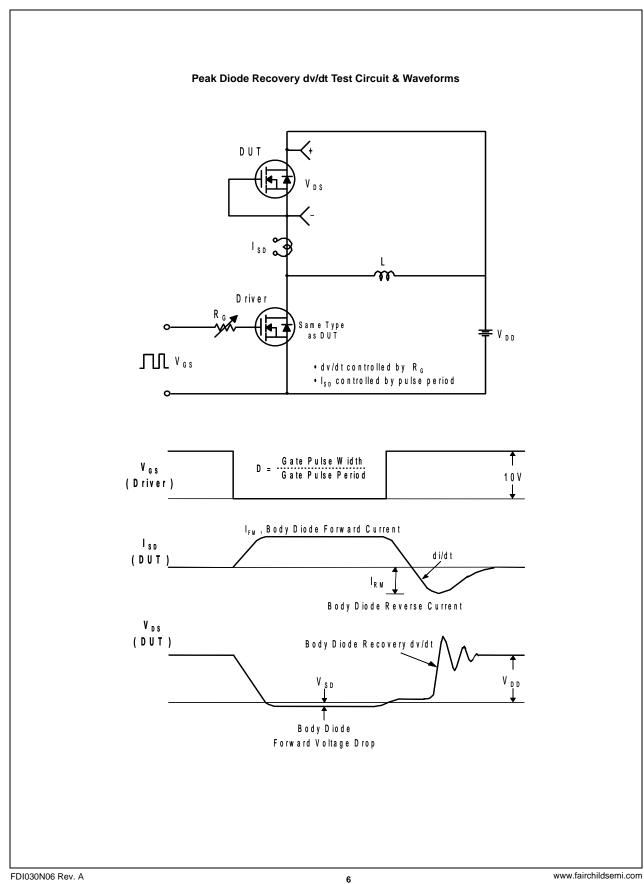
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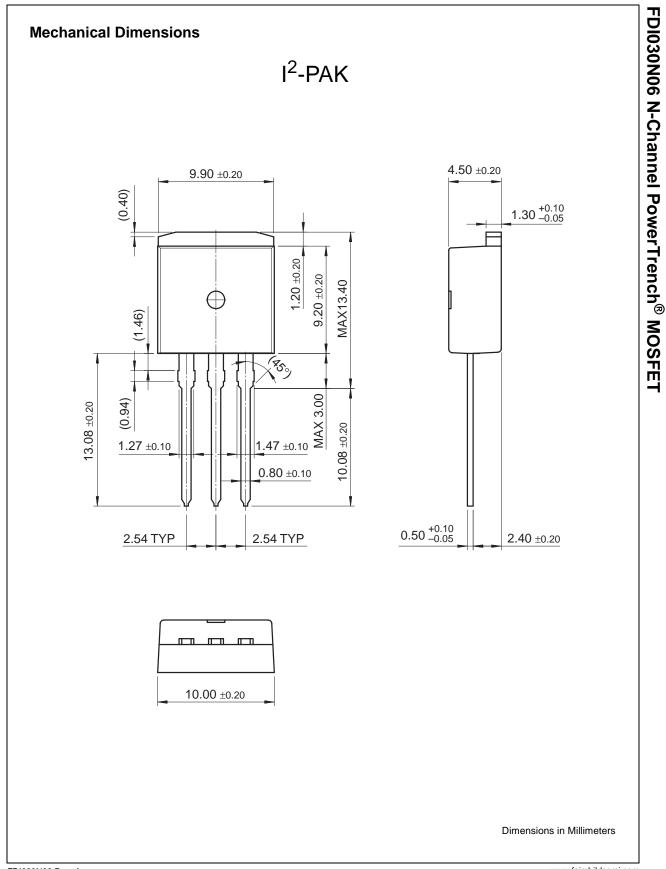


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